

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Classification::
Suggested Group Art Unit::
CD-ROM or CD_R?:: None
Number of CD disks::
Number of copies of CDs::
Sequence Submission:: No
Computer Readable Form (CRF)?:: No
Title:: LEAD FRAME, RESIN-ENCAPSULATED
SEMICONDUCTOR DEVICE, AND METHOD OF
PRODUCING THE SAME
Attorney Docket Number:: 10873.1294US01
Request For Early Publication:: No
Request For Non-Publication:: No
Suggested Drawing Figure:: 1A and 1B
Total Drawing Sheets:: 8
Small Entity:: No
Latin Name::
Variety Denomination Name::
Petition Included:: No
Petition Type::
Licensed US Govt. Agency::
Contract or Grant Numbers::
Secrecy Order in Parent Appl.?:: No

Initial 08/29/03

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Masanori
Middle Name::
Family Name:: MINAMIO
Name Suffix::
City of Residence:: Takatsuki-shi
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: 2-10-7, Utsukushigaoka
City of mailing address:: Takatsuki-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 569-1111

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Haruto
Middle Name::
Family Name:: NAGATA
Name Suffix::
City of Residence:: Sakai-shi
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: 5-1-14 Higashimikunigaoka-cho

Initial 08/29/03

City of mailing address:: Sakai-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 591-8046

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Tetsushi
Middle Name::
Family Name:: NISHIO
Name Suffix::
City of Residence:: Kyoto-shi
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: 10-205, Koudan Fushiminoushodanchi,
Noushoshimono 1, Fushimi-ku
City of mailing address:: Kyoto-shi
State or Province of mailing address:: Kyoto
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 612-8267

Correspondence Information

Correspondence Customer Number:: 23552

Representative Information

Representative Customer Number::	23552
----------------------------------	-------

Initial 08/29/03

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-254369	08/30/02	Yes

Assignee Information

Assignee Name:: Matsushita Electric Industrial Co., Ltd.
Street of mailing address:: 1006, Oaza Kadoma
City of mailing address:: Kadoma-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 571-8501

Initial 08/29/03